

## AD7470/AD7472

### FEATURES

Specified for  $V_{DD}$  of 2.7 V to 5.25 V

1.75 MSPS for AD7470 (10-Bit)

1.5 MSPS for AD7472 (12-Bit)

#### Low Power

**AD7470:** 3.34 mW Typ at 1.5 MSPS with 3 V Supplies  
7.97 mW Typ at 1.75 MSPS with 5 V Supplies

**AD7472:** 3.54 mW Typ at 1.2 MSPS with 3 V Supplies  
8.7 mW Typ at 1.5 MSPS with 5 V Supplies

#### Wide Input Bandwidth

70 dB Typ SNR at 500 kHz Input Frequency

Flexible Power/Throughput Rate Management

No Pipeline Delays

High Speed Parallel Interface

Sleep Mode: 50 nA Typ

24-Lead SOIC and TSSOP Packages

### GENERAL DESCRIPTION

The AD7470/AD7472 are 10-bit/12-bit high speed, low power, successive approximation ADCs. The parts operate from a single 2.7 V to 5.25 V power supply and feature throughput rates up to 1.5 MSPS for the 12-bit AD7472 and up to 1.75 MSPS for the 10-bit AD7470. The parts contain a low noise, wide bandwidth track-and-hold amplifier that can handle input frequencies in excess of 1 MHz.

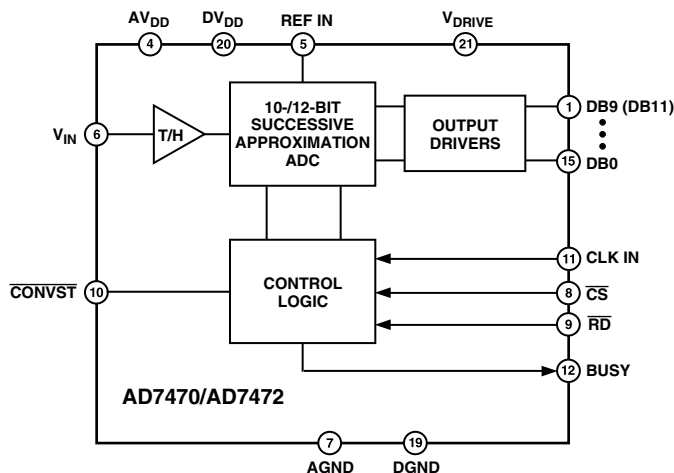
The conversion process and data acquisition are controlled using standard control inputs, allowing easy interfacing to microprocessors or DSPs. The input signal is sampled on the falling edge of  $\overline{\text{CONVST}}$ , and conversion is also initiated at this point.  $\text{BUSY}$  goes high at the start of conversion and goes low 531.66 ns after falling edge of  $\overline{\text{CONVST}}$  (AD7472 with a clock frequency of 26 MHz) to indicate that the conversion is complete. There are no pipeline delays associated with the parts. The conversion result is accessed via standard  $\overline{\text{CS}}$  and  $\overline{\text{RD}}$  signals over a high speed parallel interface.

The AD7470/AD7472 use advanced design techniques to achieve very low power dissipation at high throughput rates. With 3 V supplies and 1.5 MSPS throughput rates, the AD7470 typically consumes, on average, just 1.1 mA. With 5 V supplies and 1.75 MSPS, the average current consumption is typically 1.6 mA. The part also offers flexible power/throughput rate management. Operating the AD7470 with 3 V supplies and 500 kSPS throughput reduces the current consumption to 713  $\mu\text{A}$ . At 5 V supplies and 500 kSPS, the part consumes 944  $\mu\text{A}$ .

### REV. B

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### FUNCTIONAL BLOCK DIAGRAM



AD7470 IS A 10-BIT PART WITH DB0 TO DB9 AS OUTPUTS.  
AD7472 IS A 12-BIT PART WITH DB0 TO DB11 AS OUTPUTS.

It is also possible to operate the parts in an auto sleep mode, where the part wakes up to do a conversion and automatically enters sleep mode at the end of conversion. This method allows very low power dissipation numbers at lower throughput rates. In this mode, the AD7472 can be operated with 3 V supplies at 100 kSPS, and consume an average current of just 124  $\mu\text{A}$ . At 5 V supplies and 100 kSPS, the average current consumption is 171  $\mu\text{A}$ .

The analog input range for the part is 0 V to REF IN. The 2.5 V reference is applied externally to the REF IN pin. The conversion rate is determined by the externally-applied clock.

### PRODUCT HIGHLIGHTS

1. High Throughput with Low Power Consumption. The AD7470 offers 1.75 MSPS throughput and the AD7472 offers 1.5 MSPS throughput rates with 4 mW power consumption.
2. Flexible Power/Throughput Rate Management. The conversion rate is determined by an externally-applied clock allowing the power to be reduced as the conversion rate is reduced. The part also features an auto sleep mode to maximize power efficiency at lower throughput rates.
3. No Pipeline Delay. The part features a standard successive approximation ADC with accurate control of the sampling instant via a  $\overline{\text{CONVST}}$  input and once off conversion control.

# AD7470/AD7472

## AD7470—SPECIFICATIONS<sup>1</sup> ( $V_{DD} = 2.7 \text{ V to } 5.25 \text{ V}^2$ , REF IN = 2.5 V, $f_{CLKIN} = 30 \text{ MHz @ } 5 \text{ V}$ and $24 \text{ MHz @ } 3 \text{ V}$ ; $T_A = T_{MIN}$ to $T_{MAX}$ <sup>3</sup>, unless otherwise noted.)

| Parameter                              | A Version <sup>1</sup>    |                   | Unit                | Test Conditions/Comments                                                            |
|----------------------------------------|---------------------------|-------------------|---------------------|-------------------------------------------------------------------------------------|
| <b>DYNAMIC PERFORMANCE</b>             | <b>5 V</b>                | <b>3 V</b>        |                     | $f_S = 1.75 \text{ MSPS @ } 5 \text{ V}$ , $f_S = 1.5 \text{ MSPS @ } 3 \text{ V}$  |
| Signal to Noise + Distortion (SINAD)   | 60                        | 60                | dB min              | $f_{IN} = 500 \text{ kHz}$ Sine Wave                                                |
| Signal-to-Noise Ratio (SNR)            | 60                        | 60                | dB min              | $f_{IN} = 100 \text{ kHz}$ Sine Wave                                                |
| Total Harmonic Distortion (THD)        | 60                        | 60                | dB min              | $f_{IN} = 500 \text{ kHz}$ Sine Wave                                                |
| Peak Harmonic or Spurious Noise (SFDR) | 60                        | 60                | dB min              | $f_{IN} = 100 \text{ kHz}$ Sine Wave                                                |
| Intermodulation Distortion (IMD)       | –83                       | –83               | dB typ              | $f_{IN} = 500 \text{ kHz}$ Sine Wave                                                |
| Second-Order Terms                     | –75                       | –75               | dB max              | $f_{IN} = 100 \text{ kHz}$ Sine Wave                                                |
| Third-Order Terms                      | –85                       | –85               | dB typ              | $f_{IN} = 500 \text{ kHz}$ Sine Wave                                                |
| Aperture Delay                         | –75                       | –75               | dB max              | $f_{IN} = 100 \text{ kHz}$ Sine Wave                                                |
| Aperture Jitter                        | –79                       | –75               | dB typ              | $f_{IN} = 500 \text{ kHz}$ Sine Wave                                                |
| Full Power Bandwidth                   | –75                       | –75               | dB max              | $f_{IN} = 100 \text{ kHz}$ Sine Wave                                                |
| DC ACCURACY                            |                           |                   |                     | $f_S = 1.75 \text{ MSPS @ } 5 \text{ V}$ ; $f_S = 1.5 \text{ MSPS @ } 3 \text{ V}$  |
| Resolution                             | 10                        | 10                | Bits                |                                                                                     |
| Integral Nonlinearity                  | $\pm 1$                   | $\pm 1$           | LSB max             |                                                                                     |
| Differential Nonlinearity              | $\pm 0.9$                 | $\pm 0.9$         | LSB max             | Guaranteed No Missed Codes to 10 Bits                                               |
| Offset Error                           | $\pm 2.5$                 | $\pm 2.5$         | LSB max             |                                                                                     |
| Gain Error                             | $\pm 1$                   | $\pm 1$           | LSB max             |                                                                                     |
| <b>ANALOG INPUT</b>                    |                           |                   |                     |                                                                                     |
| Input Voltage Ranges                   | 0 to REF IN               | 0 to REF IN       | V                   |                                                                                     |
| DC Leakage Current                     | $\pm 1$                   | $\pm 1$           | $\mu\text{A}$ max   |                                                                                     |
| Input Capacitance                      | 33                        | 33                | pF typ              |                                                                                     |
| <b>REFERENCE INPUT</b>                 |                           |                   |                     |                                                                                     |
| REF IN Input Voltage Range             | 2.5                       | 2.5               | V                   | $\pm 1\%$ for Specified Performance                                                 |
| DC Leakage Current                     | $\pm 1$                   | $\pm 1$           | $\mu\text{A}$ max   |                                                                                     |
| Input Capacitance                      | 10/20                     | 10/20             | pF typ              | Track-and-Hold Mode                                                                 |
| <b>LOGIC INPUTS</b>                    |                           |                   |                     |                                                                                     |
| Input High Voltage, $V_{INH}$          | 2.4                       | 2.4               | V min               |                                                                                     |
| Input Low Voltage, $V_{INL}$           | 0.4                       | 0.4               | V max               |                                                                                     |
| Input Current, $I_{IN}$                | $\pm 1$                   | $\pm 1$           | $\mu\text{A}$ max   | Typically 10 nA, $V_{IN} = 0 \text{ V}$ or $V_{DD}$                                 |
| Input Capacitance, $C_{IN}^4$          | 10                        | 10                | pF max              |                                                                                     |
| <b>LOGIC OUTPUTS</b>                   |                           |                   |                     |                                                                                     |
| Output High Voltage, $V_{OH}$          | $V_{DRIVE} - 0.2$         | $V_{DRIVE} - 0.2$ | V min               | $I_{SOURCE} = 200 \mu\text{A}$                                                      |
| Output Low Voltage, $V_{OL}$           | 0.4                       | 0.4               | V max               | $I_{SINK} = 200 \mu\text{A}$                                                        |
| Floating-State Leakage Current         | $\pm 10$                  | $\pm 10$          | $\mu\text{A}$ max   | $V_{DD} = 2.7 \text{ V to } 5.25 \text{ V}$                                         |
| Floating-State Output Capacitance      | 10                        | 10                | pF max              |                                                                                     |
| Output Coding                          | Straight (Natural) Binary |                   |                     |                                                                                     |
| <b>CONVERSION RATE</b>                 |                           |                   |                     |                                                                                     |
| Conversion Time                        | 12                        | 12                | CLK IN Cycles (max) |                                                                                     |
| Track-and-Hold Acquisition Time        | 135                       | 135               | ns min              |                                                                                     |
| Throughput Rate                        | 1.75                      | 1.5               | MSPS max            | Conversion Time + Acquisition Time<br>CLK IN of 30 MHz @ 5 V and 24 MHz @ 3 V       |
| <b>POWER REQUIREMENTS</b>              |                           |                   |                     |                                                                                     |
| $V_{DD}^5$                             | +2.7/+5.25                |                   | V min/max           |                                                                                     |
| $I_{DD}^5$                             |                           |                   |                     | Digital Inputs = 0 V or $DV_{DD}$                                                   |
| Normal Mode                            | 2.4                       |                   | mA max              | $V_{DD} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $f_S = 1.75 \text{ MSPS}$ ; Typ 2 mA |
| Quiescent Current                      | 900                       |                   | $\mu\text{A}$ max   | $V_{DD} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $f_S = 1.75 \text{ MSPS}$            |
| Normal Mode                            | 1.5                       |                   | mA max              | $V_{DD} = 2.7 \text{ V to } 3.3 \text{ V}$ ; $f_S = 1.5 \text{ MSPS}$ ; Typ 1.3 mA  |
| Quiescent Current                      | 800                       |                   | $\mu\text{A}$ max   | $V_{DD} = 2.7 \text{ V to } 3.3 \text{ V}$ ; $f_S = 1.5 \text{ MSPS}$               |
| Sleep Mode                             | 1                         |                   | $\mu\text{A}$ max   | CLK IN = 0 V or $DV_{DD}$                                                           |
| Power Dissipation <sup>5</sup>         |                           |                   |                     | Digital Inputs = 0 V or $DV_{DD}$                                                   |
| Normal Mode                            | 12                        |                   | mW max              | $V_{DD} = 5 \text{ V}$                                                              |
| Sleep Mode                             | 4.5                       |                   | mW max              | $V_{DD} = 3 \text{ V}$                                                              |
|                                        | 5                         |                   | $\mu\text{W}$ max   | $V_{DD} = 5 \text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                                  |
|                                        | 3                         |                   | $\mu\text{W}$ max   | $V_{DD} = 3 \text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                                  |

### NOTES

<sup>1</sup>Temperature ranges as follows: A Version:  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

<sup>2</sup>The AD7470 functionally works at 2.35 V. Typical specifications @  $25^\circ\text{C}$  for SNR (100 kHz) = 59 dB; THD (100 kHz) = –84 dB; INL  $\pm 0.8$  LSB.

<sup>3</sup>The AD7470 will typically maintain A-grade performance up to  $125^\circ\text{C}$ , with a reduced CLK of 20 MHz @ 5 V and 16 MHz @ 3 V. Typical sleep mode current @  $125^\circ\text{C}$  is 700 nA.

<sup>4</sup>Sample tested @  $25^\circ\text{C}$  to ensure compliance.

<sup>5</sup>See Power vs. Throughput Rate section.

Specifications subject to change without notice.

AD7472—SPECIFICATIONS<sup>1</sup>

( $V_{DD} = 2.7\text{ V to }5.25\text{ V}^2$ , REF IN = 2.5 V, A and B Versions:  $f_{CLKIN} = 26\text{ MHz @ }5\text{ V}$  and  $20\text{ MHz @ }3\text{ V}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.)

| Parameter                                | A Version <sup>1</sup>    |                           | B Version <sup>1</sup>    |                           | Unit                | Test Conditions/Comments                                                      |
|------------------------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------|-------------------------------------------------------------------------------|
| <b>DYNAMIC PERFORMANCE</b>               | <b>5 V</b>                | <b>3 V</b>                | <b>5 V</b>                | <b>3 V</b>                |                     | $f_S = 1.5\text{ MSPS @ }5\text{ V}$ , $f_S = 1.2\text{ MSPS @ }3\text{ V}$   |
| Signal to Noise + Distortion (SINAD)     | 69                        | 69                        | 69                        | 69                        | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | 68                        | 68                        | 68                        | 68                        | dB min              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Signal-to-Noise Ratio (SNR)              | 70                        | 70                        | 70                        | 70                        | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | 68                        | 68                        | 68                        | 68                        | dB min              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Total Harmonic Distortion (THD)          | -83                       | -78                       | -83                       | -78                       | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | -83                       | -84                       | -83                       | -84                       | dB typ              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
|                                          | -75                       | -75                       | -75                       | -75                       | dB max              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Peak Harmonic or Spurious Noise (SFDR)   | -86                       | -81                       | -86                       | -81                       | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | -86                       | -86                       | -86                       | -86                       | dB typ              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
|                                          | -76                       | -76                       | -76                       | -76                       | dB max              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Intermodulation Distortion (IMD)         |                           |                           |                           |                           |                     |                                                                               |
| Second-Order Terms                       | -77                       | -77                       | -77                       | -77                       | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | -86                       | -86                       | -86                       | -86                       | dB typ              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Third-Order Terms                        | -77                       | -77                       | -77                       | -77                       | dB typ              | $f_{IN} = 500\text{ kHz Sine Wave}$                                           |
|                                          | -86                       | -86                       | -86                       | -86                       | dB typ              | $f_{IN} = 100\text{ kHz Sine Wave}$                                           |
| Aperture Delay                           | 5                         | 5                         | 5                         | 5                         | ns typ              |                                                                               |
| Aperture Jitter                          | 15                        | 15                        | 15                        | 15                        | ps typ              |                                                                               |
| Full Power Bandwidth                     | 20                        | 20                        | 20                        | 20                        | MHz typ             | @ 3 dB                                                                        |
| <b>DC ACCURACY</b>                       |                           |                           |                           |                           |                     | $f_S = 1.5\text{ MSPS @ }5\text{ V}$ , $f_S = 1.2\text{ MSPS @ }3\text{ V}$   |
| Resolution                               | 12                        | 12                        | 12                        | 12                        | Bits                |                                                                               |
| Integral Nonlinearity                    | ±2                        | ±2                        | ±1                        | ±1                        | LSB max             | Guaranteed No Missed Codes to 11 Bits (A Version)                             |
| Differential Nonlinearity                | ±1.8                      | ±1.8                      | ±0.9                      | ±0.9                      | LSB max             | Guaranteed No Missed Codes to 12 Bits (B Version)                             |
| Offset Error                             | ±10                       | ±10                       | ±10                       | ±10                       | LSB max             |                                                                               |
| Gain Error                               | ±2                        | ±2                        | ±2                        | ±2                        | LSB max             |                                                                               |
| <b>ANALOG INPUT</b>                      |                           |                           |                           |                           |                     |                                                                               |
| Input Voltage Ranges                     | 0 to REF IN               | 0 to REF IN               | 0 to REF IN               | 0 to REF IN               | V                   |                                                                               |
| DC Leakage Current                       | ±1                        | ±1                        | ±1                        | ±1                        | μA max              |                                                                               |
| Input Capacitance                        | 33                        | 33                        | 33                        | 33                        | pF typ              |                                                                               |
| <b>REFERENCE INPUT</b>                   |                           |                           |                           |                           |                     |                                                                               |
| REF IN Input Voltage Range               | 2.5                       | 2.5                       | 2.5                       | 2.5                       | V                   | ±1% for Specified Performance                                                 |
| DC Leakage Current                       | ±1                        | ±1                        | ±1                        | ±1                        | μA max              |                                                                               |
| Input Capacitance                        | 10/20                     | 10/20                     | 10/20                     | 10/20                     | pF typ              | Track-and-Hold Mode                                                           |
| <b>LOGIC INPUTS</b>                      |                           |                           |                           |                           |                     |                                                                               |
| Input High Voltage, $V_{INH}$            | 2.4                       | 2.4                       | 2.4                       | 2.4                       | V min               |                                                                               |
| Input Low Voltage, $V_{INL}$             | 0.4                       | 0.4                       | 0.4                       | 0.4                       | V max               |                                                                               |
| Input Current, $I_{IN}$                  | ±1                        | ±1                        | ±1                        | ±1                        | μA max              | Typically 10 nA, $V_{IN} = 0\text{ V or }V_{DD}$                              |
| Input Capacitance, $C_{IN}$ <sup>3</sup> | 10                        | 10                        | 10                        | 10                        | pF max              |                                                                               |
| <b>LOGIC OUTPUTS</b>                     |                           |                           |                           |                           |                     |                                                                               |
| Output High Voltage, $V_{OH}$            | $V_{DRIVE} - 0.2$         | $V_{DRIVE} - 0.2$         | $V_{DRIVE} - 0.2$         | $V_{DRIVE} - 0.2$         | V min               | $I_{SOURCE} = 200\text{ μA}$                                                  |
| Output Low Voltage, $V_{OL}$             | 0.4                       | 0.4                       | 0.4                       | 0.4                       | V max               | $I_{SINK} = 200\text{ μA}$                                                    |
| Floating-State Leakage Current           | ±10                       | ±10                       | ±10                       | ±10                       | μA max              | $V_{DD} = 2.7\text{ V to }5.25\text{ V}$                                      |
| Floating-State Output Capacitance        | 10                        | 10                        | 10                        | 10                        | pF max              |                                                                               |
| Output Coding                            | Straight (Natural) Binary | Straight (Natural) Binary | Straight (Natural) Binary | Straight (Natural) Binary |                     |                                                                               |
| <b>CONVERSION RATE</b>                   |                           |                           |                           |                           |                     |                                                                               |
| Conversion Time                          | 14                        | 14                        | 14                        | 14                        | CLK IN Cycles (max) |                                                                               |
| Track-and-Hold Acquisition Time          | 135                       | 135                       | 135                       | 135                       | ns min              |                                                                               |
| Throughput Rate                          | 1.5                       | 1.2                       | 1.5                       | 1.2                       | MSPS max            | Conversion Time + Acquisition Time                                            |
| <b>POWER REQUIREMENTS</b>                |                           |                           |                           |                           |                     |                                                                               |
| $V_{DD}$                                 | +2.7/+5.25                | +2.7/+5.25                | +2.7/+5.25                | +2.7/+5.25                | V min/max           |                                                                               |
| $I_{DD}$ <sup>4</sup>                    |                           |                           |                           |                           |                     | Digital Inputs = 0 V or $DV_{DD}$                                             |
| Normal Mode                              | 2.4                       | 2.4                       | 2.4                       | 2.4                       | mA max              | $V_{DD} = 4.75\text{ V to }5.25\text{ V}$ ; Typ 2 mA; $f_S = 1.5\text{ MSPS}$ |
| Quiescent Current                        | 900                       | 900                       | 900                       | 900                       | μA max              | $V_{DD} = 4.75\text{ V to }5.25\text{ V}$ ; $f_S = 1.5\text{ MSPS}$           |
| Normal Mode                              | 1.5                       | 1.5                       | 1.5                       | 1.5                       | mA max              | $V_{DD} = 2.7\text{ V to }3.3\text{ V}$ ; Typ 1.3 mA; $f_S = 1.2\text{ MSPS}$ |
| Quiescent Current                        | 800                       | 800                       | 800                       | 800                       | μA max              | $V_{DD} = 2.7\text{ V to }3.3\text{ V}$ ; $f_S = 1.2\text{ MSPS}$             |
| Sleep Mode                               | 1                         | 1                         | 1                         | 1                         | μA max              | CLK IN = 0 V or $DV_{DD}$                                                     |
| Power Dissipation <sup>4</sup>           |                           |                           |                           |                           |                     | Digital Inputs = 0 V or $DV_{DD}$                                             |
| Normal Mode                              | 12                        | 12                        | 12                        | 12                        | mW max              | $V_{DD} = 5\text{ V}$                                                         |
|                                          | 4.5                       | 4.5                       | 4.5                       | 4.5                       | mW max              | $V_{DD} = 3\text{ V}$                                                         |
| Sleep Mode                               | 5                         | 5                         | 5                         | 5                         | μW max              | $V_{DD} = 5\text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                             |
|                                          | 3                         | 3                         | 3                         | 3                         | μW max              | $V_{DD} = 3\text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                             |

## NOTES

<sup>1</sup>Temperature ranges as follows: A and B Versions: -40°C to +85°C.

<sup>2</sup>The AD7472 functionally works at 2.35 V. Typical specifications @ 25°C for SNR (100 kHz) = 68 dB; THD (100 kHz) = -84 dB; INL ±0.8 LSB.

<sup>3</sup>Sample tested @ 25°C to ensure compliance.

<sup>4</sup>See Power vs. Throughput Rate section.

Specifications subject to change without notice.

# AD7470/AD7472

## AD7472—SPECIFICATIONS<sup>1</sup> ( $V_{DD} = 2.7 \text{ V to } 5.25 \text{ V}^2$ , REF IN = 2.5 V, Y Version: $f_{CLKIN} = 20 \text{ MHz @ } 5 \text{ V}$ and $14 \text{ MHz @ } 3 \text{ V}$ ; $T_A = T_{MIN}$ to $T_{MAX}$ , unless otherwise noted.)

| Parameter                              | Y Version <sup>1</sup>    |                   | Unit                | Test Conditions/Comments                                                           |
|----------------------------------------|---------------------------|-------------------|---------------------|------------------------------------------------------------------------------------|
| <b>DYNAMIC PERFORMANCE</b>             | <b>5 V</b>                | <b>3 V</b>        |                     | $f_S = 1.2 \text{ MSPS @ } 5 \text{ V}$ , $f_S = 875 \text{ kSPS @ } 3 \text{ V}$  |
| Signal to Noise + Distortion (SINAD)   | 69                        | 69                | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | 68                        | 68                | dB min              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Signal-to-Noise Ratio (SNR)            | 70                        | 70                | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | 68                        | 68                | dB min              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Total Harmonic Distortion (THD)        | -83                       | -78               | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | -83                       | -84               | dB typ              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
|                                        | -75                       | -75               | dB max              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Peak Harmonic or Spurious Noise (SFDR) | -86                       | -81               | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | -86                       | -86               | dB typ              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
|                                        | -76                       | -76               | dB max              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Intermodulation Distortion (IMD)       |                           |                   |                     |                                                                                    |
| Second-Order Terms                     | -77                       | -77               | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | -86                       | -86               | dB typ              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Third-Order Terms                      | -77                       | -77               | dB typ              | $f_{IN} = 500 \text{ kHz Sine Wave}$                                               |
|                                        | -86                       | -86               | dB typ              | $f_{IN} = 100 \text{ kHz Sine Wave}$                                               |
| Aperture Delay                         | 5                         | 5                 | ns typ              |                                                                                    |
| Aperture Jitter                        | 15                        | 15                | ps typ              |                                                                                    |
| Full Power Bandwidth                   | 20                        | 20                | MHz typ             | @ 3 dB                                                                             |
| <b>DC ACCURACY</b>                     |                           |                   |                     | $f_S = 1.2 \text{ MSPS @ } 5 \text{ V}$ ; $f_S = 875 \text{ kSPS @ } 3 \text{ V}$  |
| Resolution                             | 12                        | 12                | Bits                |                                                                                    |
| Integral Nonlinearity                  | $\pm 2$                   | $\pm 2$           | LSB max             |                                                                                    |
| Differential Nonlinearity              | $\pm 1.8$                 | $\pm 1.8$         | LSB max             | Guaranteed No Missed Codes to 11 Bits                                              |
| Offset Error                           | $\pm 10$                  | $\pm 10$          | LSB max             |                                                                                    |
| Gain Error                             | $\pm 2$                   | $\pm 2$           | LSB max             |                                                                                    |
| <b>ANALOG INPUT</b>                    |                           |                   |                     |                                                                                    |
| Input Voltage Ranges                   | 0 to REF IN               | 0 to REF IN       | V                   |                                                                                    |
| DC Leakage Current                     | $\pm 1$                   | $\pm 1$           | $\mu\text{A max}$   |                                                                                    |
| Input Capacitance                      | 33                        | 33                | pF typ              |                                                                                    |
| <b>REFERENCE INPUT</b>                 |                           |                   |                     |                                                                                    |
| REF IN Input Voltage Range             | 2.5                       | 2.5               | V                   | $\pm 1\%$ for Specified Performance                                                |
| DC Leakage Current                     | $\pm 1$                   | $\pm 1$           | $\mu\text{A max}$   |                                                                                    |
| Input Capacitance                      | 10/20                     | 10/20             | pF typ              | Track-and-Hold Mode                                                                |
| <b>LOGIC INPUTS</b>                    |                           |                   |                     |                                                                                    |
| Input High Voltage, $V_{INH}$          | 2.4                       | 2.4               | V min               |                                                                                    |
| Input Low Voltage, $V_{INL}$           | 0.4                       | 0.4               | V max               |                                                                                    |
| Input Current, $I_{IN}$                | $\pm 1$                   | $\pm 1$           | $\mu\text{A max}$   | Typically 10 nA, $V_{IN} = 0 \text{ V}$ or $V_{DD}$                                |
| Input Capacitance, $C_{IN}^3$          | 10                        | 10                | pF max              |                                                                                    |
| <b>LOGIC OUTPUTS</b>                   |                           |                   |                     |                                                                                    |
| Output High Voltage, $V_{OH}$          | $V_{DRIVE} - 0.2$         | $V_{DRIVE} - 0.2$ | V min               | $I_{SOURCE} = 200 \mu\text{A}$                                                     |
| Output Low Voltage, $V_{OL}$           | 0.4                       | 0.4               | V max               | $I_{SINK} = 200 \mu\text{A}$                                                       |
| Floating-State Leakage Current         | $\pm 10$                  | $\pm 10$          | $\mu\text{A max}$   | $V_{DD} = 2.7 \text{ V to } 5.25 \text{ V}$                                        |
| Floating-State Output Capacitance      | 10                        | 10                | pF max              |                                                                                    |
| Output Coding                          | Straight (Natural) Binary |                   |                     |                                                                                    |
| <b>CONVERSION RATE</b>                 |                           |                   |                     |                                                                                    |
| Conversion Time                        | 14                        | 14                | CLK IN Cycles (max) |                                                                                    |
| Track-and-Hold Acquisition Time        | 140                       | 140               | ns min              |                                                                                    |
| Throughput Rate                        | 1200                      | 875               | kSPS max            | Conversion Time + Acquisition Time                                                 |
| <b>POWER REQUIREMENTS</b>              |                           |                   |                     |                                                                                    |
| $V_{DD}$                               | +2.7/+5.25                |                   | V min/max           |                                                                                    |
| $I_{DD}^4$                             |                           |                   |                     | Digital Inputs = 0 V or $DV_{DD}$                                                  |
| Normal Mode                            | 2.4                       |                   | mA max              | $V_{DD} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $f_S = 1.2 \text{ MSPS}$ ; Typ 2 mA |
| Quiescent Current                      | 900                       |                   | $\mu\text{A max}$   | $V_{DD} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $f_S = 1.2 \text{ MSPS}$            |
| Normal Mode                            | 1.5                       |                   | mA max              | $V_{DD} = 2.7 \text{ V to } 3.3 \text{ V}$ ; $f_S = 875 \text{ kSPS}$ ; Typ 1.3 mA |
| Quiescent Current                      | 800                       |                   | $\mu\text{A max}$   | $V_{DD} = 2.7 \text{ V to } 3.3 \text{ V}$ ; $f_S = 875 \text{ kSPS}$              |
| Sleep Mode                             | 2                         |                   | $\mu\text{A max}$   | CLK IN = 0 V or $DV_{DD}$                                                          |
| Power Dissipation <sup>4</sup>         |                           |                   |                     | Digital Inputs = 0 V or $DV_{DD}$                                                  |
| Normal Mode                            | 12                        |                   | mW max              | $V_{DD} = 5 \text{ V}$                                                             |
|                                        | 4.5                       |                   | mW max              | $V_{DD} = 3 \text{ V}$                                                             |
| Sleep Mode                             | 10                        |                   | $\mu\text{W max}$   | $V_{DD} = 5 \text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                                 |
|                                        | 6                         |                   | $\mu\text{W max}$   | $V_{DD} = 3 \text{ V}$ ; CLK IN = 0 V or $DV_{DD}$                                 |

### NOTES

<sup>1</sup>Temperature ranges as follows: Y Version:  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

<sup>2</sup>The AD7472 functionally works at 2.35 V. Typical specifications @  $25^\circ\text{C}$  for SNR (100 kHz) = 68 dB; THD (100 kHz) = -84 dB; INL  $\pm 0.8$  LSB.

<sup>3</sup>Sample tested @  $25^\circ\text{C}$  to ensure compliance.

<sup>4</sup>See Power vs. Throughput Rate section.

Specifications subject to change without notice.

# TIMING SPECIFICATIONS<sup>1</sup> ( $V_{DD} = 2.7\text{ V to } 5.25\text{ V}$ , $REF\ IN = 2.5\text{ V}$ ; $T_A = T_{MIN}$ to $T_{MAX}$ , unless otherwise noted.)

| Parameter              | Limit at $T_{MIN}$ , $T_{MAX}$ |          | Unit               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|------------------------|--------------------------------|----------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                        | AD7470                         | AD7472   |                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $f_{CLK}$ <sup>2</sup> | 10<br>30                       | 10<br>26 | kHz min<br>MHz max | $t_{CLK} = 1/f_{CLK\ IN}$<br>Wake-Up Time<br>$\overline{CONVST}$ Pulse Width<br>$\overline{CONVST}$ to $BUSY$ Delay,<br>$V_{DD} = 5\text{ V}$ , A and B Versions<br>$V_{DD} = 5\text{ V}$ , Y Version<br>$V_{DD} = 3\text{ V}$ , A and B Versions<br>$V_{DD} = 3\text{ V}$ , Y Version<br>$BUSY$ to $\overline{CS}$ Setup Time<br>$\overline{CS}$ to $\overline{RD}$ Setup Time<br>$\overline{RD}$ Pulse Width<br>Data Access Time After Falling Edge of $\overline{RD}$<br>Bus Relinquish Time After Rising Edge of $\overline{RD}$<br>$\overline{CS}$ to $\overline{RD}$ Hold Time<br>Acquisition Time<br>A and B Versions<br>Y Version<br>Quiet Time |
| $t_{CONVERT}$          | 436.42                         | 531.66   | ns min             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_{WAKEUP}$           | 1                              | 1        | $\mu s$ max        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_1$                  | 10                             | 10       | ns min             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_2$                  | 10                             | 10       | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                        |                                | 15       | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                        | 30                             | 30       | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                        |                                | 35       | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_3$                  | 0                              | 0        | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_4$ <sup>3</sup>     | 0                              | 0        | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_5$                  | 20                             | 20       | ns min             | Data Access Time After Falling Edge of $\overline{RD}$<br>Bus Relinquish Time After Rising Edge of $\overline{RD}$<br>$\overline{CS}$ to $\overline{RD}$ Hold Time<br>Acquisition Time<br>A and B Versions<br>Y Version<br>Quiet Time                                                                                                                                                                                                                                                                                                                                                                                                                   |
| $t_6$ <sup>3</sup>     | 15                             | 15       | ns min             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_7$ <sup>4</sup>     | 8                              | 8        | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_8$                  | 0                              | 0        | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_9$                  | 135                            | 135      | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                        |                                | 140      | ns max             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $t_{10}$               | 100                            | 100      | ns min             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |

## NOTES

<sup>1</sup>Sample tested at 25°C to ensure compliance. All input signals are specified with  $t_r = t_f = 5\text{ ns}$  (10% to 90% of  $V_{DD}$ ) and timed from a voltage level of 1.6 V.

See Figure 1.

<sup>2</sup>Mark/Space ratio for the CLK inputs is 40/60 to 60/40. First CLK pulse should be 10 ns min from falling edge of  $\overline{CONVST}$ .

<sup>3</sup>Measured with the load circuit of Figure 1 and defined as the time required for the output to cross 0.8 V or 2.0 V.

<sup>4</sup> $t_7$  is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1. The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time,  $t_7$ , quoted in the timing characteristics, is the true bus relinquish time of the part and is independent of the bus loading.

Specifications subject to change without notice.

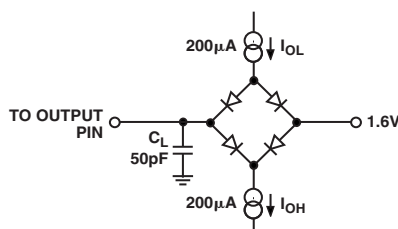


Figure 1. Load Circuit for Digital Output Timing Specifications

# AD7470/AD7472

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

(T<sub>A</sub> = 25°C unless otherwise noted.)

|                                                       |                                    |
|-------------------------------------------------------|------------------------------------|
| AV <sub>DD</sub> to AGND/DGND                         | −0.3 V to +7 V                     |
| DV <sub>DD</sub> to AGND/DGND                         | −0.3 V to +7 V                     |
| V <sub>DRIVE</sub> to AGND/DGND                       | −0.3 V to +7 V                     |
| AV <sub>DD</sub> to DV <sub>DD</sub>                  | −0.3 V to +0.3 V                   |
| V <sub>DRIVE</sub> to DV <sub>DD</sub>                | −0.3 V to DV <sub>DD</sub> + 0.3 V |
| AGND to DGND                                          | −0.3 V to +0.3 V                   |
| Analog Input Voltage to AGND                          | −0.3 V to AV <sub>DD</sub> + 0.3 V |
| Digital Input Voltage to DGND                         | −0.3 V to DV <sub>DD</sub> + 0.3 V |
| REF IN to AGND                                        | −0.3 V to AV <sub>DD</sub> + 0.3 V |
| Input Current to Any Pin Except Supplies <sup>2</sup> | ±10 mA                             |
| Operating Temperature Range                           |                                    |
| Commercial (A and B Versions)                         | −40°C to +85°C                     |
| Industrial (Y Version)                                | −40°C to +125°C                    |
| Storage Temperature Range                             | −65°C to +150°C                    |

|                                   |                 |
|-----------------------------------|-----------------|
| Junction Temperature              | 150°C           |
| θ <sub>JA</sub> Thermal Impedance | 75°C/W (SOIC)   |
|                                   | 115°C/W (TSSOP) |
| θ <sub>JC</sub> Thermal Impedance | 25°C/W (SOIC)   |
|                                   | 35°C/W (TSSOP)  |
| Lead Temperature, Soldering       |                 |
| Vapor Phase (60 sec)              | 215°C           |
| Infrared (15 sec)                 | 220°C           |
| ESD                               | 1.5 kV          |

## NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

<sup>2</sup>Transient currents of up to 100 mA will not cause SCR latch-up.

## ORDERING GUIDE

| Model                          | Temperature Range | Resolution (Bits) | Package Options <sup>1</sup> | Package Description |
|--------------------------------|-------------------|-------------------|------------------------------|---------------------|
| AD7470ARU                      | −40°C to +85°C    | 10                | RU-24                        | TSSOP               |
| AD7470ARU-REEL                 | −40°C to +85°C    | 10                | RU-24                        | TSSOP               |
| AD7470ARU-REEL7                | −40°C to +85°C    | 10                | RU-24                        | TSSOP               |
| AD7472AR                       | −40°C to +85°C    | 12                | R-24                         | SOIC                |
| AD7472AR-REEL                  | −40°C to +85°C    | 12                | R-24                         | SOIC                |
| AD7472AR-REEL7                 | −40°C to +85°C    | 12                | R-24                         | SOIC                |
| AD7472ARU                      | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472ARU-REEL                 | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472ARU-REEL7                | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472BR                       | −40°C to +85°C    | 12                | R-24                         | SOIC                |
| AD7472BR-REEL                  | −40°C to +85°C    | 12                | R-24                         | SOIC                |
| AD7472BRU                      | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472BRU-REEL                 | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472BRU-REEL7                | −40°C to +85°C    | 12                | RU-24                        | TSSOP               |
| AD7472YR                       | −40°C to +125°C   | 12                | R-24                         | SOIC                |
| AD7472YR-REEL                  | −40°C to +125°C   | 12                | R-24                         | SOIC                |
| AD7472YRU                      | −40°C to +125°C   | 12                | RU-24                        | TSSOP               |
| AD7472YRU-REEL                 | −40°C to +125°C   | 12                | RU-24                        | TSSOP               |
| AD7472YRU-REEL7                | −40°C to +125°C   | 12                | RU-24                        | TSSOP               |
| EVAL-AD7470CB <sup>2</sup>     |                   |                   |                              | Evaluation Board    |
| EVAL-AD7472CB <sup>2</sup>     |                   |                   |                              | Evaluation Board    |
| EVAL CONTROL BRD2 <sup>3</sup> |                   |                   |                              | Controller Board    |

## NOTES

<sup>1</sup>R = SOIC; RU = TSSOP.

<sup>2</sup>This can be used as a standalone evaluation board or in conjunction with the EVAL-CONTROL BOARD for evaluation/demonstration purposes.

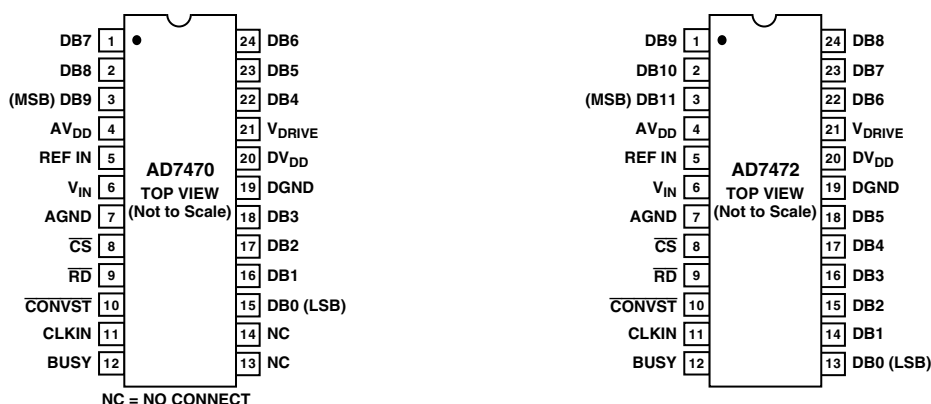
<sup>3</sup>This board is a complete unit allowing a PC to control and communicate with all Analog Devices evaluation boards ending in the CB designators. To order a complete evaluation kit, you need to order the specific ADC evaluation board, for example, EVAL-AD7472CB, the EVAL CONTROL BRD2, and a 12 V ac transformer. See the relevant evaluation board application note for more information.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7470/AD7472 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## PIN CONFIGURATIONS



## PIN FUNCTION DESCRIPTIONS

| Mnemonic            | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $\overline{CS}$     | Chip Select. Active low logic input used in conjunction with $\overline{RD}$ to access the conversion result. The conversion result is placed on the data bus following the falling edge of both $\overline{CS}$ and $\overline{RD}$ . $\overline{CS}$ and $\overline{RD}$ are both connected to the same AND gate on the input so the signals are interchangeable. $\overline{CS}$ can be hardwired permanently low.                                                                                                                                                                                               |
| $\overline{RD}$     | Read Input. Logic input used in conjunction with $\overline{CS}$ to access the conversion result. The conversion result is placed on the data bus following the falling edge of both $\overline{CS}$ and $\overline{RD}$ . $\overline{CS}$ and $\overline{RD}$ are both connected to same AND gate on the input so the signals are interchangeable. $\overline{CS}$ and $\overline{RD}$ can be hardwired permanently low, in which case the data bus is always active and the result of the new conversion is clocked out slightly before to the BUSY line going low.                                               |
| $\overline{CONVST}$ | Conversion Start Input. Logic input used to initiate conversion. The input track-and-hold amplifier goes from track mode to hold mode on the falling edge of $\overline{CONVST}$ , and the conversion process is initiated at this point. The conversion input can be as narrow as 10 ns. If the $\overline{CONVST}$ input is kept low for the duration of conversion and is still low at the end of conversion, the part will automatically enter sleep mode. If the part enters this sleep mode, the next rising edge of $\overline{CONVST}$ wakes up the part. Wake-up time for the part is typically 1 $\mu$ s. |
| CLK IN              | Master Clock Input. The clock source for the conversion process is applied to this pin. Conversion time for the AD7472 takes 14 clock cycles, and conversion time for the AD7470 takes 12 clock cycles. The frequency of this master clock input, therefore, determines the conversion time and achievable throughput rate. While the ADC is not converting, the clock-in pad is in three-state and thus no clock is going through the part.                                                                                                                                                                        |
| BUSY                | BUSY Output. Logic output indicating the status of the conversion process. The BUSY signal goes high after the falling edge of $\overline{CONVST}$ and stays high for the duration of conversion. Once conversion is complete and the conversion result is in the output register, the BUSY line returns low. The track-and-hold returns to track mode just prior to the falling edge of BUSY, and the acquisition time for the part begins when BUSY goes low. If the $\overline{CONVST}$ input is still low when BUSY goes low, the part automatically enters its sleep mode on the falling edge of BUSY.         |
| REF IN              | Reference Input. An external reference must be applied to this input. The voltage range for the external reference is 2.5 V $\pm$ 1% for specified performance.                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| AV <sub>DD</sub>    | Analog Supply Voltage, 2.7 V to 5.25 V. This is the only supply voltage for all analog circuitry on the AD7470/AD7472. The AV <sub>DD</sub> and DV <sub>DD</sub> voltages should ideally be at the same potential and must not be more than 0.3 V apart even on a transient basis. This supply should be decoupled to AGND.                                                                                                                                                                                                                                                                                         |
| DV <sub>DD</sub>    | Digital Supply Voltage, 2.7 V to 5.25 V. This is the supply voltage for all digital circuitry on the AD7470/AD7472 aside from the output drivers. The DV <sub>DD</sub> and AV <sub>DD</sub> voltages should ideally be at the same potential and must not be more than 0.3 V apart even on a transient basis. This supply should be decoupled to DGND.                                                                                                                                                                                                                                                              |
| AGND                | Analog Ground. Ground reference point for all analog circuitry on the AD7470/AD7472. All analog input signals and any external reference signal should be referred to this AGND voltage. The AGND and DGND voltages should ideally be at the same potential and must not be more than 0.3 V apart even on a transient basis.                                                                                                                                                                                                                                                                                        |

# AD7470/AD7472

## PIN FUNCTION DESCRIPTIONS (continued)

| Mnemonic           | Function                                                                                                                                                                                                                                                                                                                 |
|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DGND               | Digital Ground. This is the ground reference point for all digital circuitry on the AD7470 and AD7472. The DGND and AGND voltages should ideally be at the same potential and must not be more than 0.3 V apart even on a transient basis.                                                                               |
| V <sub>IN</sub>    | Analog Input. Single-ended analog input channel. The input range is 0 V to REF IN. The analog input presents a high dc input impedance.                                                                                                                                                                                  |
| V <sub>DRIVE</sub> | Supply Voltage for the Output Drivers, 2.7 V to 5.25 V. This voltage determines the output high voltage for the data output pins. It allows AV <sub>DD</sub> and DV <sub>DD</sub> to operate at 5 V (and maximize the dynamic performance of the (ADC), while the digital outputs can interface to 3 V logic.            |
| DB0–DB9/11         | Data Bit 0 to Data Bit 9 (AD7470) and DB11 (AD7472). Parallel digital outputs that provide the conversion result for the part. These are three-state outputs that are controlled by $\overline{CS}$ and $\overline{RD}$ . The output high voltage level for these outputs is determined by the V <sub>DRIVE</sub> input. |

## TERMINOLOGY

### Integral Nonlinearity

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, a point 1/2 LSB below the first code transition, and full scale, a point 1/2 LSB above the last code transition.

### Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

### Offset Error

This is the deviation of the first code transition (00 . . . 000) to (00 . . . 001) from the ideal, i.e., AGND + 0.5 LSB.

### Gain Error

The last transition should occur at the analog value 1.5 LSB below the nominal full scale. The first transition is a 0.5 LSB above the low end of the scale (zero in the case of AD7470/AD7472). The gain error is the deviation of the actual difference between the first and last code transitions from the ideal difference between the first and last code transitions with offset errors removed.

### Track-and-Hold Acquisition Time

The track-and-hold amplifier returns into track mode after the end of conversion. Track-and-Hold acquisition time is the time required for the output of the track-and-hold amplifier to reach its final value, within  $\pm 1$  LSB, after the end of conversion.

### Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $f_s/2$ ), excluding dc. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by

$$\text{Signal to (Noise + Distortion)} = (6.02 N + 1.76) \text{ dB}$$

Thus for a 12-bit converter, this is 74 dB and for a 10-bit converter is 62 dB.

### Total Harmonic Distortion (THD)

Total harmonic distortion is the ratio of the rms sum of harmonics to the fundamental. For the AD7470/AD7472 it is defined as

$$\text{THD (dB)} = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1}$$

where  $V_1$  is the rms amplitude of the fundamental and  $V_2$ ,  $V_3$ ,  $V_4$ ,  $V_5$ , and  $V_6$  are the rms amplitudes of the second through the sixth harmonics.

### Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to  $f_s/2$  and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it will be a noise peak.

### Intermodulation Distortion

With inputs consisting of sine waves at two frequencies,  $f_a$  and  $f_b$ , any active device with nonlinearities will create distortion products at sum and difference frequencies of  $m f_a \pm n f_b$  where  $m, n = 0, 1, 2, 3$ , etc. Intermodulation distortion terms are those for which neither  $m$  nor  $n$  is equal to zero. For example, the second-order terms include  $(f_a + f_b)$  and  $(f_a - f_b)$ , while the third-order terms include  $(2f_a + f_b)$ ,  $(2f_a - f_b)$ ,  $(f_a + 2f_b)$  and  $(f_a - 2f_b)$ .

The AD7470/AD7472 are tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second-order terms are usually distanced in frequency from the original sine waves while the third-order terms are usually at a frequency close to the input frequencies. As a result, the second- and third-order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in dBs.

### Aperture Delay

In a sample-and-hold, the time required after the hold command for the switch to open fully is the aperture delay. The sample is, in effect, delayed by this interval, and the hold command would have to be advanced by this amount for precise timing.

### Aperture Jitter

Aperture jitter is the range of variation in the aperture delay. In other words, it is the uncertainty about when the sample is taken. Jitter is the result of noise which modulates the phase of the hold command. This specification establishes the ultimate timing error, hence the maximum sampling frequency for a given resolution. This error will increase as the input  $dV/dt$  increases.



### ADC TRANSFER FUNCTION

The output coding of the AD7470/AD7472 is straight binary. The designed code transitions occur midway between successive integer LSB values (0.5 LSB, 1.5 LSB, etc). The LSB size is equal to  $(\text{REF IN})/4096$  for the AD7472 and to  $(\text{REF IN})/1024$  for the AD7470. The ideal transfer characteristic for the AD7472 is shown in Figure 6.

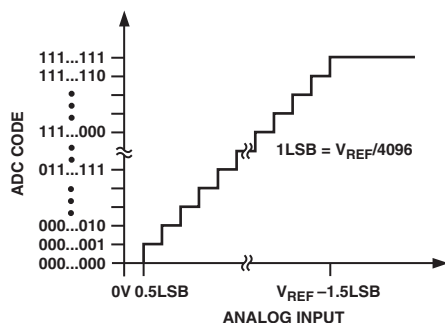


Figure 6. Transfer Characteristic for 12 Bits

### AC ACQUISITION TIME

In ac applications it is recommended to always buffer analog input signals. The source impedance of the drive circuitry must be kept as low as possible to minimize the acquisition time of the ADC. Large values of impedance at the  $V_{\text{IN}}$  pin of the ADC will cause the THD to degrade at high input frequencies.

The AD8021, AD8047, AD8051, AD9631, and AD797 are some of the op amps that could be used to buffer the analog input. Figure 7 shows the AD7470/AD7472 performance for some of those recommended input buffers.

| INPUT<br>BUFFERS | AD7470/AD7472<br>DYNAMIC<br>PERFORMANCE<br>SPECIFICATIONS |               | TYPICAL AMPLIFIER<br>CURRENT<br>CONSUMPTION |
|------------------|-----------------------------------------------------------|---------------|---------------------------------------------|
|                  | SNR<br>500kHz                                             | THD<br>500kHz |                                             |
| AD8047           | 70                                                        | 78            | 5.8mA                                       |
| AD9631           | 69.5                                                      | 80            | 17mA                                        |
| AD8051           | 68.6                                                      | 78            | 4.4mA                                       |
| AD797            | 70                                                        | 84            | 8.2mA                                       |

Figure 7. Recommended Input Buffers

### Reference Input

The following references are best suited for use with the AD7470/AD7472.

ADR291  
AD780  
REF192  
ADR421

For optimum performance, a 2.5 V reference is recommended. The parts can function with a reference up to 3 V and down to 2 V, but the performance deteriorates.

### DC ACQUISITION TIME

The ADC starts a new acquisition phase at the end of a conversion and ends it on the falling edge of the  $\overline{\text{CONVST}}$  signal. At the end of conversion there is a settling time associated with the sampling circuit. This settling time lasts approximately 135 ns. The analog signal on  $V_{\text{IN}}$  is also being acquired during this settling time; therefore, the minimum acquisition time needed is approximately 135 ns.

Figure 8 shows the equivalent charging circuit for the sampling capacitor when the ADC is in its acquisition phase. R3 represents the source impedance of a buffer amplifier or resistive network, R1 is an internal switch resistance, R2 is for bandwidth control, and C1 is the sampling capacitor. C2 is back-plate capacitance and switch parasitic capacitance.

During the acquisition phase the sampling capacitor must be charged to within  $\pm 1$  LSB of its final value.

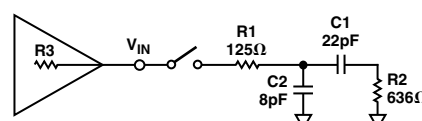


Figure 8. Equivalent Sampling Circuit

### ANALOG INPUT

Figure 9 shows the equivalent circuit of the analog input structure of the AD7470/AD7472. The two diodes, D1 and D2, provide ESD protection for the analog inputs. The capacitor C3 is typically about 4 pF and can be primarily attributed to pin capacitance. The resistor R1 is an internal switch resistance. This resistor is typically about 125  $\Omega$ . The capacitor C1 is the sampling capacitor, while R2 is used for bandwidth control.

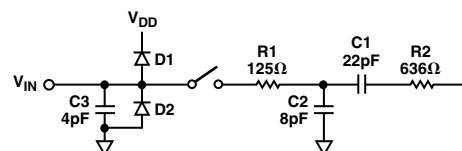


Figure 9. Equivalent Analog Input Circuit

### CLOCK SOURCES

The max CLK specification for the AD7470 is 30 MHz, and for the AD7472, it is 26 MHz. These frequencies are not standard off-the-shelf oscillator frequencies. Many manufacturers produce oscillator modules close to these frequencies; a typical one being 25.175 MHz from IQD Limited. AEL Crystals Limited produces a 25 MHz oscillator module in various packages. Crystal oscillator manufacturers will produce 26 MHz and 30 MHz oscillators to order. Of course any clock source can be used, not just crystal oscillators.

# AD7470/AD7472

## PARALLEL INTERFACE

The parallel interfaces of the AD7470 and AD7472 are 10 bits and 12 bits wide, respectively. The output data buffers are activated when both  $\overline{CS}$  and  $\overline{RD}$  are logic low. At this point, the contents of the data register are placed onto the data bus. Figure 10 shows the timing diagram for the parallel port.

Figure 11 shows the timing diagram for the parallel port when  $\overline{CS}$  and  $\overline{RD}$  are tied permanently low. In this setup, once  $\overline{BUSY}$  line goes from high to low, the conversion process is completed.

The data is available on the output bus slightly before the falling edge of  $\overline{BUSY}$ .

It is important to point out that data bus cannot change state while the ADC is doing a conversion as this would have a detrimental effect on the conversion in progress. The data out lines will go three-state again when either the  $\overline{RD}$  or the  $\overline{CS}$  line goes high. Thus the  $\overline{CS}$  can be tied low permanently, leaving the  $\overline{RD}$  line to control conversion result access. Refer to  $V_{DRIVE}$  section for output voltage levels.

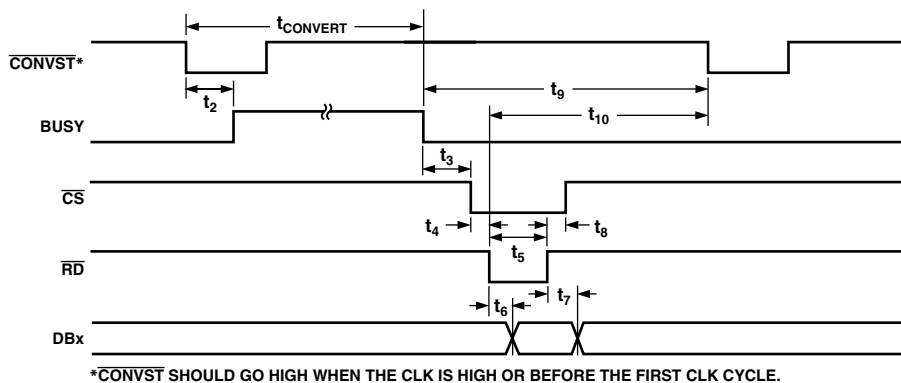


Figure 10. Parallel Port Timing

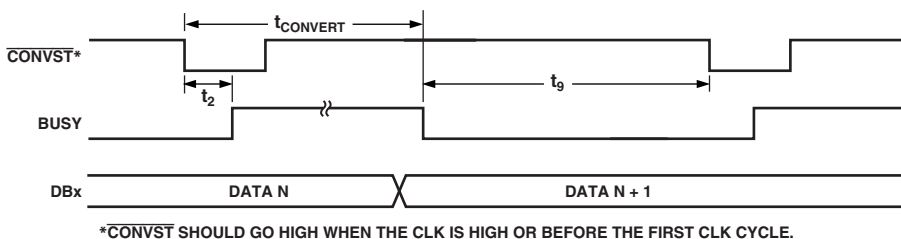


Figure 11. Parallel Port Timing with  $\overline{CS}$  and  $\overline{RD}$  Tied Low

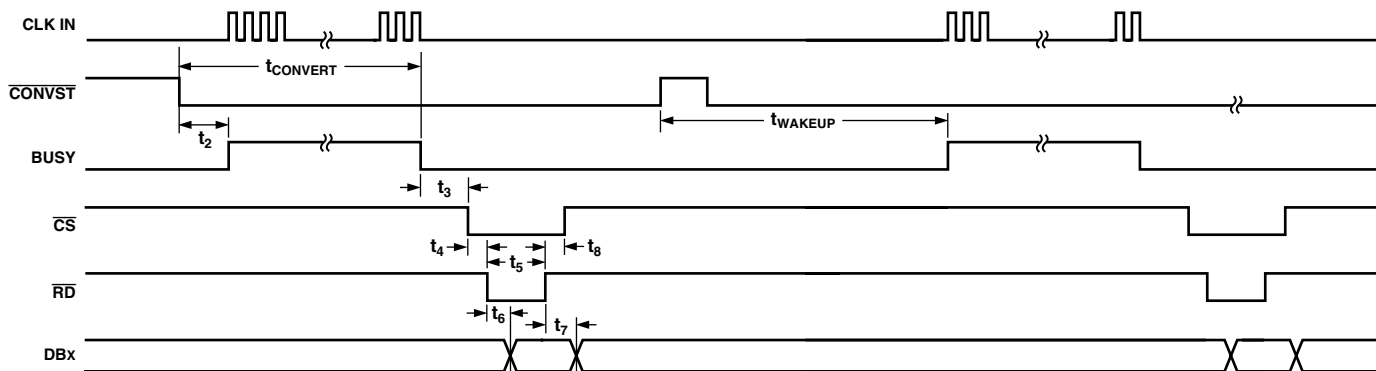


Figure 12. Wake-Up Timing Diagram (Burst Clock)

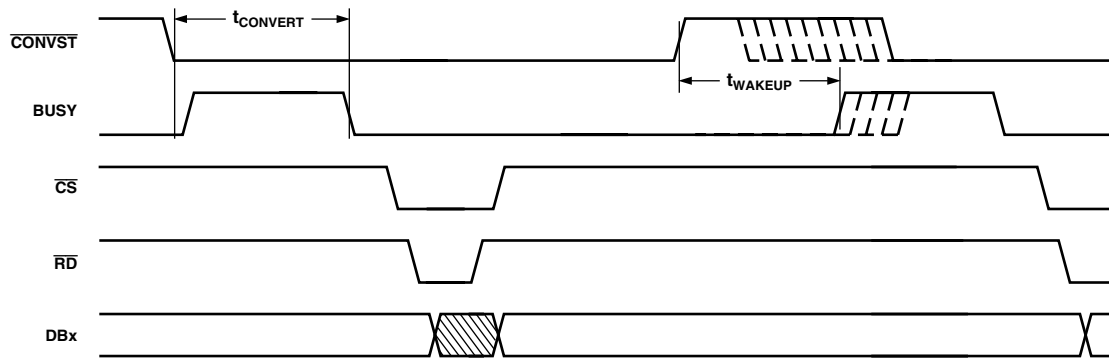


Figure 13. Mode 2 Operation

### OPERATING MODES

The AD7470 and AD7472 have two possible modes of operation, depending on the state of the  $\overline{\text{CONVST}}$  pulse at the end of a conversion, Mode 1 and Mode 2. There is a continuous clock on the CLKIN pin.

#### Mode 1 (High Speed Sampling)

In this mode of operation, the  $\overline{\text{CONVST}}$  pulse is brought high before the end of conversion i.e., before  $\text{BUSY}$  goes low (see Figure 10). If the  $\overline{\text{CONVST}}$  pin is brought from high to low while  $\text{BUSY}$  is high, the conversion is restarted. When operating in this mode, a new conversion should not be initiated until the acquisition time has elapsed after  $\text{BUSY}$  goes low. This acquisition time allows the track-and-hold circuit to accurately acquire the input signal. As mentioned earlier, a read should not be done during a conversion. This mode facilitates the fastest throughput times for the AD7470/AD7472.

#### Mode 2 (Sleep Mode)

Figure 13 shows AD7470/AD7472 in Mode 2 operation where the ADC goes into sleep mode after conversion. The  $\overline{\text{CONVST}}$  line is brought low to initiate a conversion and remains low until after the end of conversion. If  $\overline{\text{CONVST}}$  goes high and low again while  $\text{BUSY}$  is high, the conversion is restarted. Once the  $\text{BUSY}$  line goes from a high to a low, the  $\overline{\text{CONVST}}$  line has its status checked and, if low, the part enters sleep mode.

The device wakes up again on the rising edge of the  $\overline{\text{CONVST}}$  signal. There is a wake-up time of typically 1  $\mu\text{s}$  after the rising edge of  $\overline{\text{CONVST}}$  before the  $\text{BUSY}$  line can go high to indicate start of conversion.  $\text{BUSY}$  will only go high once  $\overline{\text{CONVST}}$  goes low. The  $\overline{\text{CONVST}}$  line can go from a high to a low during this wake-up time, but the conversion will still not be initiated until after the 1  $\mu\text{s}$  wake-up time. Superior power performance can be achieved in this mode of operation by waking up the AD7470 and AD7472 only to carry out a conversion.

#### Burst Mode

Burst mode on the AD7470/AD7472 is a subsection of Mode 1 and Mode 2; the clock is noncontinuous. Figure 12 shows how the ADC works in burst mode for Mode 2. The clock needs to be switched on only during conversion, a minimum of 12 clock cycles for the AD7470 and 14 clock cycles for the AD7472. Because the clock is off during nonconverting intervals, system power is saved. The  $\text{BUSY}$  signal can be used to gate the CLKIN pulses. The ADC does not begin the conversion process until

the first CLKIN rising edge after  $\text{BUSY}$  goes high. The clock needs to start less than two clock cycles away from the  $\overline{\text{CONVST}}$  active edge, otherwise INL deteriorates. For example, if the clock frequency is 28 MHz, the clock must start within 71.4 ns of  $\overline{\text{CONVST}}$  going low. In Figure 12, the A/D converter section is put into sleep mode once conversion is completed. On the rising edge of  $\overline{\text{CONVST}}$ , it is woken up again. The user must be wary of the wake-up time because it will reduce the sampling rate of the ADC.

#### V<sub>DRIVE</sub>

The  $V_{\text{DRIVE}}$  pin is used as the voltage supply to the output drivers and is a separate supply from  $\text{AV}_{\text{DD}}$  and  $\text{DV}_{\text{DD}}$ . The purpose of using a separate supply for the output drivers is that the user can vary the output high voltage,  $V_{\text{OH}}$ , from the  $V_{\text{DD}}$  supply to the AD7470/AD7472. For example, if  $\text{AV}_{\text{DD}}$  and  $\text{DV}_{\text{DD}}$  is using a 5 V supply, the  $V_{\text{DRIVE}}$  pin can be powered from a 3 V supply. The ADC has better dynamic performance at 5 V than at 3 V, so operating the part at 5 V, while still being able to interface to 3 V parts, pushes the AD7470/AD7472 to the top bracket of high performance 10-bit/12-bit ADCs. Of course, the ADC can have its  $V_{\text{DRIVE}}$  and  $\text{DV}_{\text{DD}}$  pins connected together and be powered from a 3 V or 5 V supply.

All outputs are powered from  $V_{\text{DRIVE}}$ . These are all the data out pins and the  $\text{BUSY}$  pin. The  $\overline{\text{CONVST}}$ ,  $\overline{\text{CS}}$ ,  $\overline{\text{RD}}$ , and CLKIN signals are related to the  $\text{DV}_{\text{DD}}$  voltage.

### POWER-UP

It is recommended that the user perform a dummy conversion after power-up, because the first conversion result could be incorrect. This also ensures that the part is in the correct mode of operation. The recommended power-up sequence is as follows:

1. GND
2.  $V_{\text{DD}}$
3.  $V_{\text{DRIVE}}$
4. Digital Inputs
5. REF IN
6.  $V_{\text{IN}}$

#### Power vs. Throughput

The two modes of operation for the AD7470 and AD7472 will produce different power versus throughput performances, Mode 1 and Mode 2; see Operating Modes section of the data sheet for more detailed descriptions of these modes. Mode 2 is the sleep mode of the part and it achieves the optimum power performance.

# AD7470/AD7472

## Mode 1

Figure 14 shows the AD7472 conversion sequence in Mode 1 using a throughput rate of 500 kSPS and a clock frequency of 26 MHz. At 5 V supply, the current consumption for the part when converting is typically 2 mA, and the quiescent current is typically 650  $\mu$ A. The conversion time of 531.66 ns contributes 2.658 mW to the overall power dissipation in the following way:

$$(531.66 \text{ ns} / 2 \mu\text{s}) \times (5 \times 2 \text{ mA}) = 2.658 \text{ mW}$$

The contribution to the total power dissipated by the remaining 1.468  $\mu$ s of the cycle is 2.38 mW.

$$(1.468 \mu\text{s} / 2 \mu\text{s}) \times (5 \times 650 \mu\text{A}) = 2.38 \text{ mW}$$

Thus the power dissipated during each cycle is

$$2.658 \text{ mW} + 2.38 \text{ mW} = 5.038 \text{ mW}$$

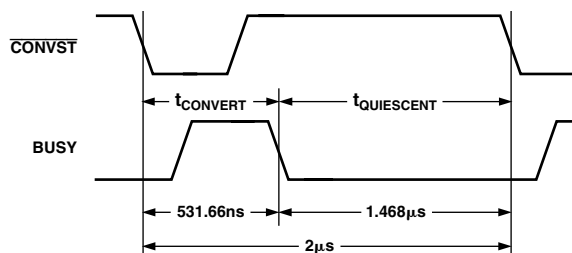


Figure 14. Mode 1 Power Dissipation

## Mode 2

Figure 15 shows the AD7472 conversion sequence in Mode 2 using a throughput rate of 500 kSPS and a clock frequency of 26 MHz. At 5 V supply, the current consumption for the part when converting is typically 2 mA, while the sleep current is 1  $\mu$ A max. The power dissipated during this power-down is negligible, and is thus not worth considering in the total power figure. During the wake-up phase, the AD7472 will draw 650  $\mu$ A typically. Overall power dissipated is

$$(531.66 \text{ ns} / 2 \mu\text{s}) \times (5 \times 2 \text{ mA}) + (1 \mu\text{s} / 2 \mu\text{s}) \times (5 \times 650 \mu\text{A}) = 4.283 \text{ mW}$$

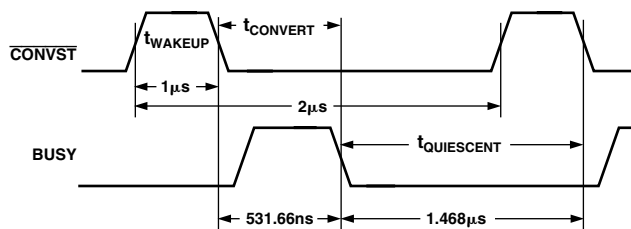
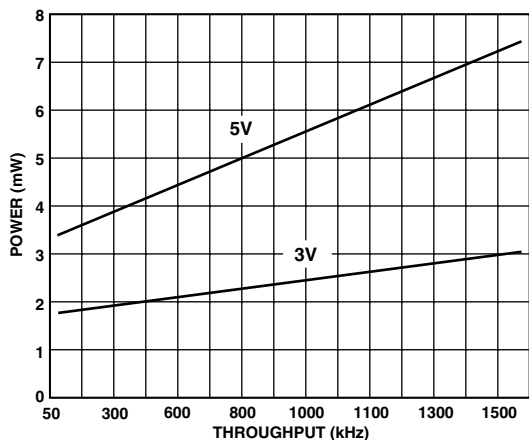


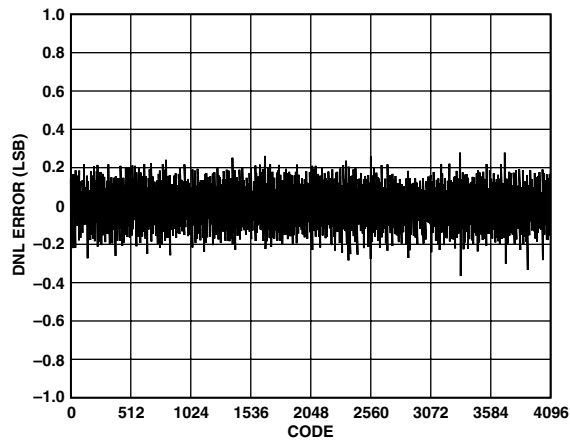
Figure 15. Mode 2 Power Dissipation

TPC 1 and TPC 2 show a typical graphical representation of Power vs. Throughput for the AD7472 when in (a) Mode 1 @ 5 V and 3 V and Mode 2 @ 5 V and 3 V

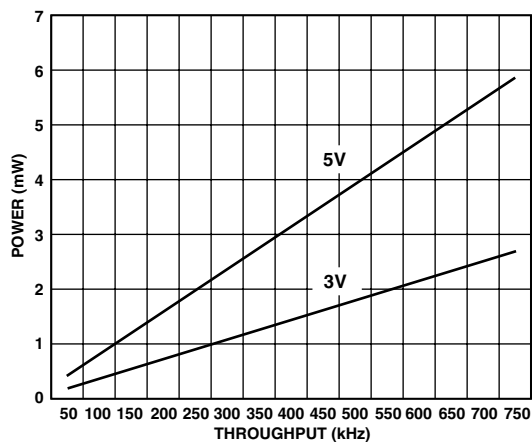
# Typical Performance Characteristics—AD7470/AD7472



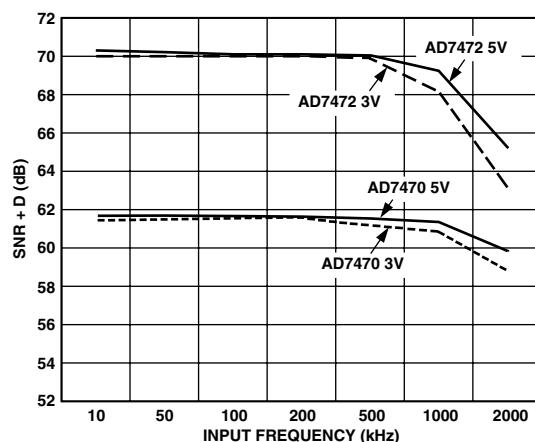
TPC 1. Power vs. Throughput (Mode 1 @ 5 V and 3 V)



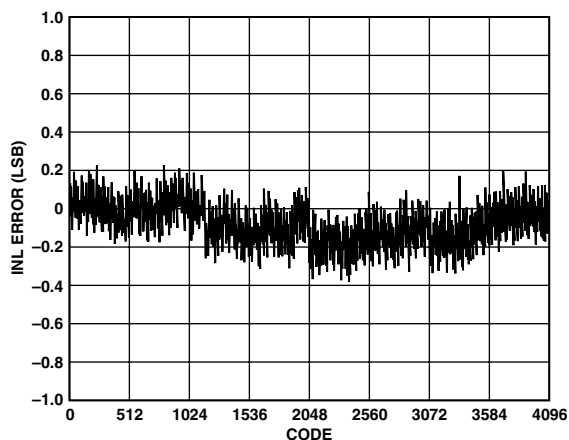
TPC 4. Typical DNL for 2.75 V @ 25°C



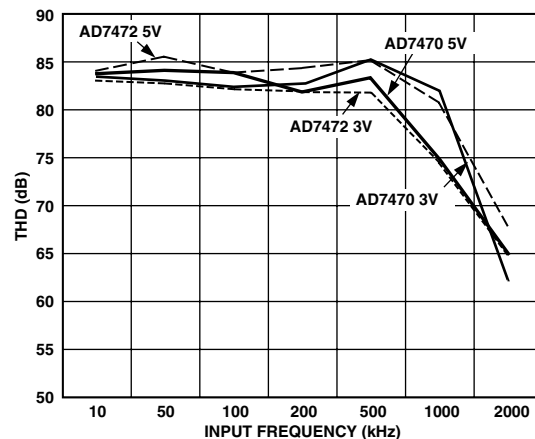
TPC 2. Power vs. Throughput (Mode 2 @ 5 V and 3 V)



TPC 5. Typical SNR + D vs. Input Tone

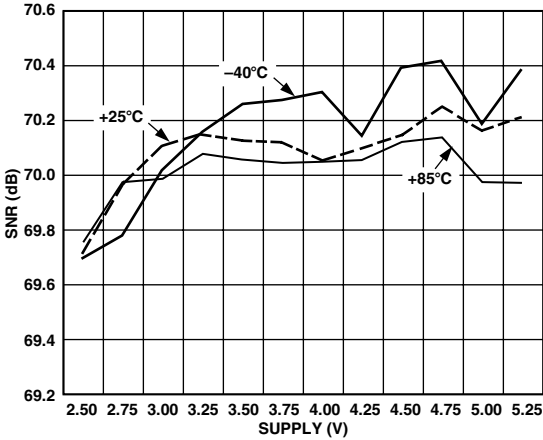


TPC 3. Typical INL for 2.75 V @ 25°C

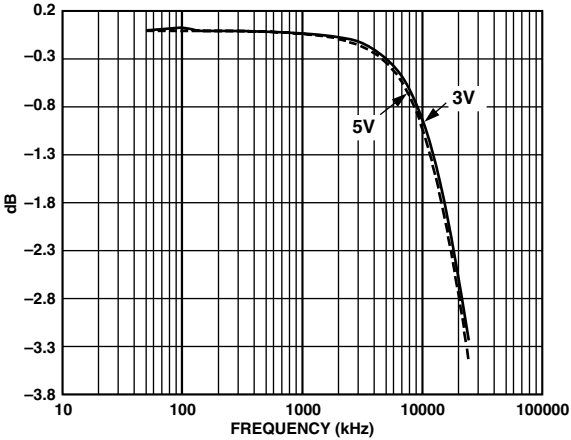


TPC 6. Typical THD vs. Input Tone

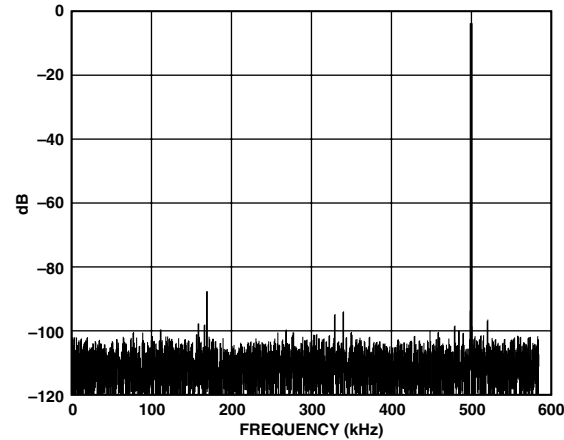
AD7470/AD7472



TPC 7. Typical SNR vs. Supply



TPC 9. Typical Bandwidth



TPC 8. Typical SNR @ 500 kHz Input Tone

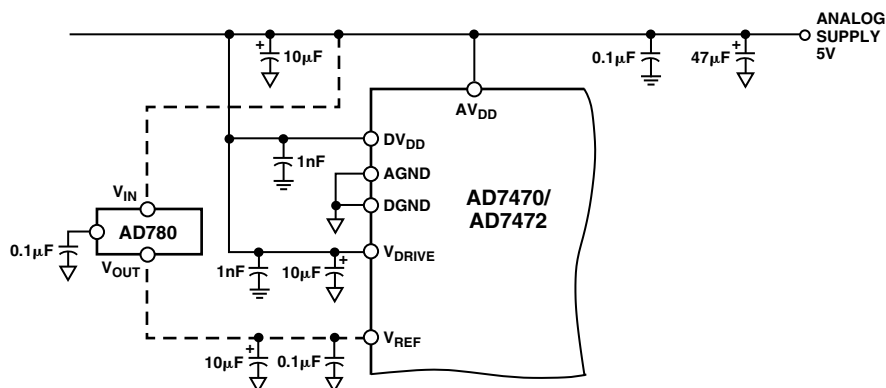


Figure 16. Decoupling Circuit

## GROUNDING AND LAYOUT

The analog and digital power supplies are independent and separately pinned out to minimize coupling between the analog and digital sections within the device. To complement the excellent noise performance of the AD7470/AD7472, it is imperative that care be given to the PCB layout. Figure 16 shows a recommended connection diagram for the AD7470/AD7472.

All of the AD7470/AD7472 ground pins should be soldered directly to a ground plane to minimize series inductance. The  $AV_{DD}$ ,  $DV_{DD}$ , and  $V_{DRIVE}$  pins should be decoupled to both the analog and digital ground planes. The large value capacitors will decouple low frequency noise to analog ground; the small value capacitors will decouple high frequency noise to digital ground. All digital circuitry power pins should be decoupled to the digital ground plane. The use of ground planes can physically separate sensitive analog components from the noisy digital system. The two ground planes should be joined in *only* one place and should not overlap so as to minimize capacitive coupling between them. If the AD7470/AD7472 is in a system where multiple devices require AGND to DGND connections, the connection should still be made at one point only, a star ground point, which should be established as close as possible to the AD7470/AD7472.

Noise can be minimized by applying some simple rules to the PCB layout: analog signals should be kept away from digital signals; fast switching signals like clocks should be shielded with digital ground to avoid radiating noise to other sections of the board and clock signals should never be run near the analog inputs; avoid running digital lines under the device as these will couple noise onto the die; the power supply lines to the AD7470/AD7472 should use as large a trace as possible to provide a low impedance path and reduce the effects of glitches on the power supply line; avoid crossover of digital and analog signals and place traces that are on opposite sides of the board at right angles to each other.

Noise to the analog power line can be further reduced by use of multiple decoupling capacitors as shown in Figure 16. Decoupling capacitors should be placed directly at the power inlet to the PCB and also as close as possible to the power pins of the AD7470/AD7472. The same decoupling method should be used on other ICs on the PCB, with the capacitor leads as short as possible to minimize lead inductance.

## POWER SUPPLIES

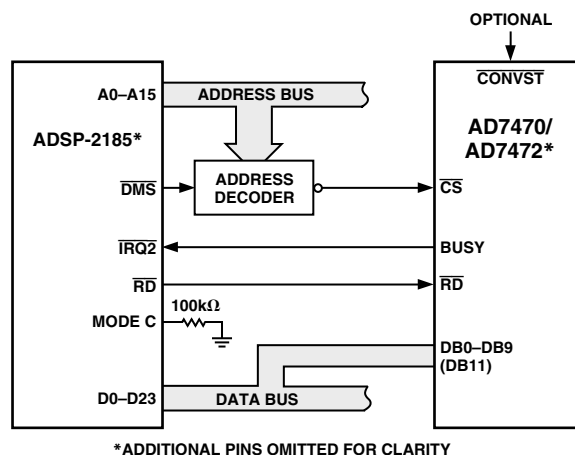
Separate power supplies for  $AV_{DD}$  and  $DV_{DD}$  are desirable but, if necessary,  $DV_{DD}$  may share its power connection to  $AV_{DD}$ . The digital supply ( $DV_{DD}$ ) must not exceed the analog supply ( $AV_{DD}$ ) by more than 0.3 V in normal operation.

## MICROPROCESSOR INTERFACING

### AD7470/AD7472 to ADSP-2185 Interface

Figure 17 shows a typical interface between the AD7470/AD7472 and the ADSP-2185. The ADSP-2185 processor can be used in one of two memory modes, full memory mode and host mode. The Mode C pin determines in which mode the processor works. The interface in Figure 17 is set up to have the processor working in full memory mode, which allows full external addressing capabilities.

When the AD7470/AD7472 has finished converting, the  $BUSY$  line requests an interrupt through the  $IRQ2$  pin. The  $IRQ2$  interrupt has to be set up in the interrupt control register as edge-sensitive. The  $\overline{DMS}$  (data memory select) pin latches in the address of the ADC into the address decoder. The read operation is thus started.



\*ADDITIONAL PINS OMITTED FOR CLARITY

Figure 17. Interfacing to the ADSP-2185

### AD7470/AD7472 to ADSP-21065 Interface

Figure 18 shows a typical interface between the AD7470/AD7472 and the ADSP-21065L SHARC® processor. This interface is an example of one of three DMA handshake modes. The  $\overline{MS}_X$

## AD7470/AD7472

control line is actually three memory select lines. Internal  $\overline{\text{ADDR}}_{25-24}$  are decoded into  $\overline{\text{MS}}_{3-0}$ ; these lines are then asserted as chip selects. The  $\overline{\text{DMAR}}_1$  (DMA Request 1) is used in this setup as the interrupt to signal end of conversion. The rest of the interface is standard handshaking operation.

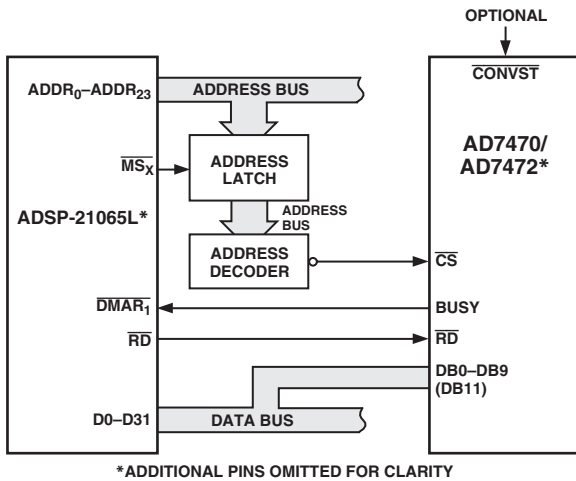


Figure 18. Interfacing to ADSP-21065L

### AD7470/AD7472 to TMS320C25 Interface

Figure 19 shows an interface between the AD7470/AD7472 and the TMS320C25. The  $\overline{\text{CONVST}}$  signal can be applied from the TMS320C25 or from an external source. The  $\overline{\text{BUSY}}$  line interrupts the digital signal processor when conversion is completed. The TMS320C25 does not have a separate  $\overline{\text{RD}}$  output to drive the AD7470/AD7472  $\overline{\text{RD}}$  input directly. This has to be generated from the processor  $\overline{\text{STRB}}$  and  $\text{R}/\overline{\text{W}}$  outputs with the addition of some glue logic. The  $\overline{\text{RD}}$  signal is OR-gated with the  $\overline{\text{MSC}}$  signal to provide the  $\overline{\text{WAIT}}$  state required in the read cycle for correct interface timing. The following instruction is used to read the conversion from the AD7470/AD7472:

*IN D,ADC*

where  $D$  is data memory address and  $ADC$  is the AD7470/AD7472 address. The read operation must not be attempted during conversion.

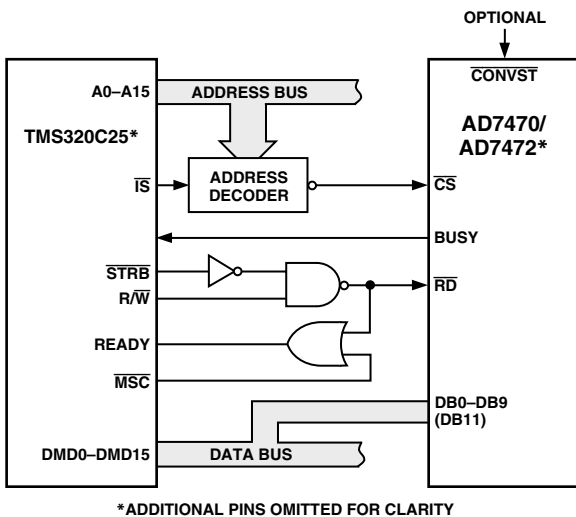


Figure 19. Interfacing to the TMS320C25

### AD7470/AD7472 to PIC17C4x Interface

Figure 20 shows a typical parallel interface between the AD7470/AD7472 and the PIC17C42/43/44. The microcontroller sees the ADC as another memory device with its own specific memory address on the memory map. The  $\overline{\text{CONVST}}$  signal can be controlled by either the microcontroller or an external source. The  $\overline{\text{BUSY}}$  signal provides an interrupt request to the microcontroller when a conversion ends. The  $\overline{\text{INT}}$  pin on the PIC17C42/43/44 must be configured to be active on the negative edge. PORTC and PORTD of the microcontroller are bidirectional and used to address the AD7470/AD7472 and also to read in the 10-bit (AD7470) or 12-bit (AD7472) data. The  $\overline{\text{OE}}$  pin on the PIC can be used to enable the output buffers on the AD7470/AD7472 and to perform a read operation.

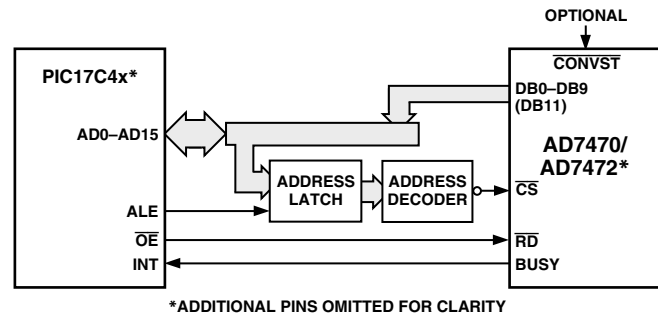


Figure 20. Interfacing to the PIC17C4x

### AD7470/AD7472 to 80C186 Interface

Figure 21 shows the AD7470/AD7472 interfaced to the 80C186 microprocessor. The 80C186 DMA controller provides two independent high speed DMA channels where data transfer can occur between memory and I/O spaces. (The AD7470/AD7472 occupies one of these I/O spaces.) Each data transfer consumes two bus cycles, one cycle to fetch data and the other to store data.

After the AD7470/AD7472 has finished conversion, the  $\overline{\text{BUSY}}$  line generates a DMA request to Channel 1 (DRQ1). As a result of the interrupt, the processor performs a DMA READ operation which also resets the interrupt latch. Sufficient priority must be assigned to the DMA channel to ensure that the DMA request will be serviced before the completion of the next conversion. This configuration can be used with 6 MHz and 8 MHz 80C186 processors.

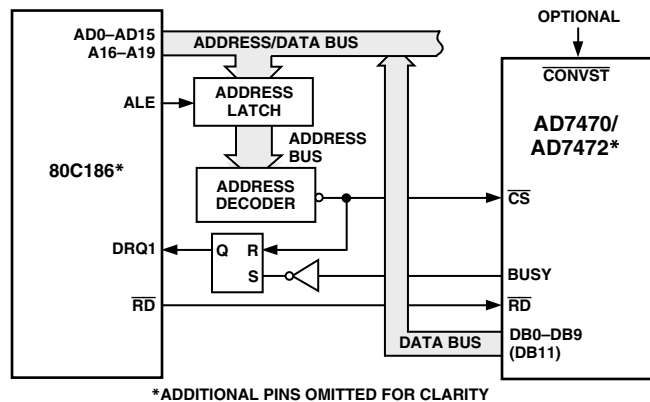
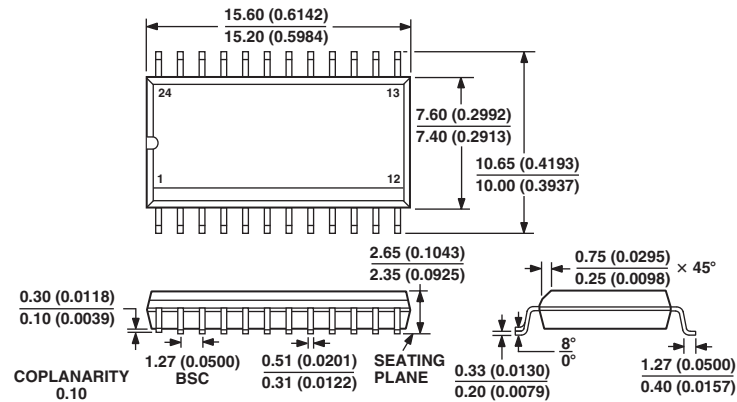


Figure 21. Interfacing to the 80C186

## OUTLINE DIMENSIONS

**24-Lead Standard Small Outline Package [SOIC]**  
**Wide Body**  
**(R-24)**

Dimensions shown in millimeters and (inches)

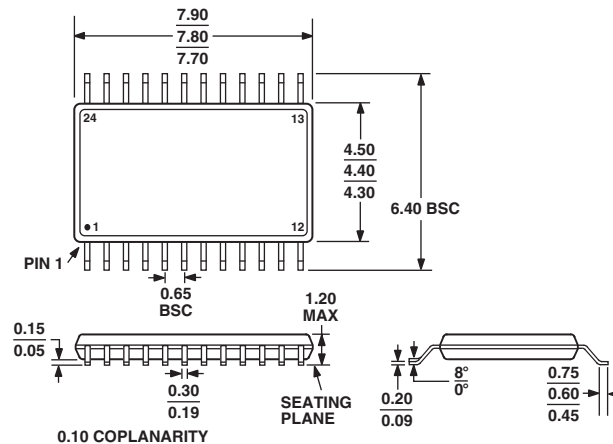


COMPLIANT TO JEDEC STANDARDS MS-013AD

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

**24-Lead Thin Shrink Small Outline Package [TSSOP]**  
**(RU-24)**

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-153AD

# AD7470/AD7472

## Revision History

| Location                                                 | Page      |
|----------------------------------------------------------|-----------|
| 10/03—Data Sheet changed from REV. A to REV. B.          |           |
| Added Y version                                          | Universal |
| Changes to SPECIFICATIONS                                | 2         |
| Changes to TIMING SPECIFICATIONS                         | 5         |
| Changes to ABSOLUTE MAXIMUM RATINGS                      | 6         |
| Changes to ORDERING GUIDE                                | 6         |
| Changes to PIN FUNCTION DESCRIPTIONS                     | 7         |
| Changes to Offset Error description                      | 9         |
| Changes to Gain Error description                        | 9         |
| Changes to OPERATING MODES section                       | 13        |
| Changes to POWER-UP section                              | 13        |
| Relabeled TPC captions and renumbered subsequent figures | 15        |
| Updated OUTLINE DIMENSIONS                               | 19        |

C01127-0-10/03(B)